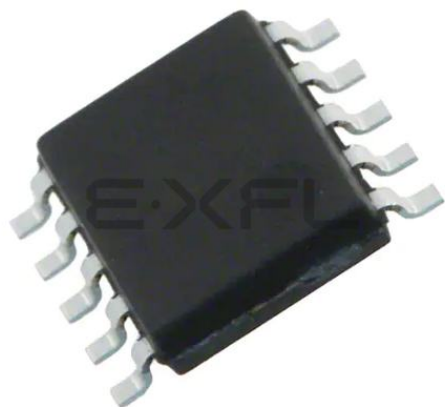




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What is "[Embedded - Microcontrollers](#)"?

"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "[Embedded - Microcontrollers](#)"

Details

Product Status	Active
Core Processor	-
Core Size	8-Bit
Speed	10MHz
Connectivity	SIO, UART/USART
Peripherals	LVD, POR, PWM, WDT
Number of I/O	7
Program Memory Size	8KB (8K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	512 x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 5.5V
Data Converters	A/D 3x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	10-LSOP (0.173", 4.40mm Width)
Supplier Device Package	10-MFPSK
Purchase URL	https://www.e-xfl.com/product-detail/onsemi/lc87f2608aumm-ah

■ Minimum Bus Cycle Time (Note1)

- 100ns (10MHz) $V_{DD}=2.7$ to 5.5V (Note2)

■ Minimum Instruction Cycle Time

- 300ns (10MHz) $V_{DD}=2.7$ to 5.5V (Note2)

Note1: The bus cycle time here refers to the ROM read speed.

Note2: Use this product in a voltage range of 3.0 to 5.5V because the minimum release voltage (PORRL) of the power-on reset (POR) circuit is $2.87V \pm 0.12V$.

■ Ports

- I/O ports

Ports whose I/O direction can be designated in 1 bit units: 7 (P10 to P12, P30 to P33)

- Reset pins: 1 ($\overline{RES}$)
- Power pins: 2 (V_{SS1} , V_{DD1})

■ Timers

- Timer 0: 16-bit timer/counter with a capture register

Mode 0: 8-bit timer with an 8-bit programmable prescaler (with an 8-bit capture register) $\times 2$ channels

Mode 1: 8-bit timer with an 8-bit programmable prescaler (with an 8-bit capture register)
+ 8-bit counter (with an 8-bit capture register)

Mode 2: 16-bit timer with an 8-bit programmable prescaler (with a 16-bit capture register)

Mode 3: 16-bit counter (with a 16-bit capture register)

- Timer 1: 16-bit timer/counter

Mode 0: 8-bit timer with an 8-bit prescaler + 8-bit timer/counter with an 8-bit prescaler

Mode 2: 16-bit timer/counter with an 8-bit prescaler

■ Serial Interface

- SIO7: 8-bit synchronous serial interface

1) LSB first/MSB first mode selectable

2) Built-in 8-bit baudrate generator (maximum transfer clock cycle = $4/3$ tCYC)

■ High-speed 12-bit PWM

- System clock/high-speed RC oscillation clock (20MHz or 40MHz) operation selectable
- Duty/period programmable
- Continuous PWM output/specific count PWM output (automatic stop) selectable

■ High-speed Pulse Width/Period Counter

- HCT1: High-speed pulse width/period counter 1

1) System clock/high-speed RC oscillation clock (20MHz or 40MHz) operation selectable

2) H-level width/L-level width/period measurement modes selectable

3) Input triggering noise filter

- HCT2: High-speed pulse width/period counter 2

1) System clock/high-speed RC oscillation clock (20MHz or 40MHz) operation selectable

2) Can measure both L-level width and period simultaneously.

3) Input triggering noise filter

4) Input trigger selectable (from 3 signals, i.e., P11/HCT2IN, P31/HCT2IN, and analog comparator output)

■ AD Converter: 12 bits × 3 channels

- 12-/8-bit AD converter resolution selectable

■ Analog Comparator

- Sends output to the P32/CMPO port (polarity selectable).
- Edge detection function (shared with INTC and also allows the selection of the noise filter function)

■ Watchdog Timer

- Can generate the internal reset signal on a timer overflow monitored by the WDT-dedicated low-speed RC oscillation clock (30kHz).
- Allows selection of continue, stop, or hold mode operation of the counter on entry into the HALT/ HOLD mode.

■ Interrupt Source Flags

- 16 sources, 10 vector addresses
 - 1) Provides three levels (low (L), high (H), and highest (X)) of multiplex interrupt control.
Any interrupt requests of the level equal to or lower than the current interrupt are not accepted.
 - 2) When interrupt requests to two or more vector addresses occur at the same time, the interrupt of the highest level takes precedence over the other interrupts.
For interrupts of the same level, the interrupt into the smallest vector address takes precedence.

No.	Vector Address	Level	Interrupt Source
1	00003H	X or L	INTA
2	0000BH	X or L	INTB
3	00013H	H or L	INTC/T0L/INTE
4	0001BH	H or L	INTD/INTF
5	00023H	H or L	T0H/SIO7
6	0002BH	H or L	T1L/T1H
7	00033H	H or L	HCT1
8	0003BH	H or L	HCT2
9	00043H	H or L	ADC/HPWM automatic stop/HPWM cycle
10	0004BH	H or L	None

- Priority levels $X > H > L$
- Of interrupts of the same level, the one with the smallest vector address takes precedence.

■ Subroutine Stack Levels: 256 levels maximum (The stack is allocated in RAM.)

■ High-speed Multiplication/Division Instructions

- 16 bits × 8 bits (5 tCYC execution time)
- 24 bits × 16 bits (12 tCYC execution time)
- 16 bits ÷ 8 bits (8 tCYC execution time)
- 24 bits ÷ 16 bits (12 tCYC execution time)

■ Oscillation Circuits

- Medium speed RC oscillation circuit (internal): For system clock (1MHz)
- Low speed RC oscillation circuit (internal): For watchdog timer (30kHz)
- High speed RC oscillation circuit (internal): For system clock (20MHz or 40MHz)
 - 1) 2 source oscillation frequencies (20MHz or 40MHz) selectable for the high-speed RC oscillation circuit by optional configuration.

■ System Clock Divider Function

- Can run on low current.
- The minimum instruction cycle selectable from 300ns, 600ns, 1.2μs, 2.4μs, 4.8μs, 9.6μs, 19.2μs, 38.4μs, and 76.8μs (when high speed RC oscillation is selected for system clock.).

■ Internal Reset Circuit

- Power-on reset (POR) function
 - 1) POR reset is generated only at power-on time.
 - 2) The POR release level can be selected from 3 levels (2.87V, 3.86V, and 4.35V) by optional configuration.
- Low-voltage detection reset (LVD) function
 - 1) LVD and POR functions are combined to generate resets when power is turned on and when power voltage falls below a certain level.
 - 2) The use or disuse of the LVD function and the low voltage threshold level (3 levels: 2.81V, 3.79V, and 4.28V) can be selected by optional configuration.

■ Standby Function

- HALT mode: Halts instruction execution while allowing the peripheral circuits to continue operation.
 - 1) Oscillation is not halted automatically.
 - 2) There are the following three ways of resetting the HALT mode.
 - (1) Setting the Reset pin to the low level
 - (2) Generating a reset signal via the watchdog timer or brown-out detector
 - (3) Having an interrupt generated
- HOLD mode: Suspends instruction execution and the operation of the peripheral circuits.
 - 1) The medium- and high-speed RC oscillation circuits automatically stop operation.
 - 2) There are the following four ways of resetting the HOLD mode.
 - (1) Setting the Reset pin to the low level
 - (2) Generating a reset signal via the watchdog timer or brown-out detector
 - (3) Setting at least one of the INTA, INTB, INTC, INTD, INTE, and INTF pins to the specified level (INTA and INTB HOLD mode reset is available only when level detection is set.)
 - (4) Applying input signals to the IN+ and IN- pins so that the analog comparator output is set to the specified level (when the analog comparator output is assigned to the INTC input)

■ On-chip Debugger Function

- Supports software debugging with the IC mounted on the target board (selectable from 3 series).
 - 1) LC87D2708A : All terminal function of LC87F2608A can be used.
 - 2) LC87F2708A : All terminal function of LC87F2608A can be used. The debug feature is limited.
 - 3) LC87F2608A : The debugger terminal function when an On-chip debugger is used cannot be used. The debug feature is limited.
- Two channels of on-chip debugger pins are available (LC87F2608A).

■ Data Security Function (Note3)

- Protects the program data stored in flash memory from unauthorized read or copy.

Note3: This data security function does not necessarily provide absolute data security.

LC87F2608A

■ Development Tools

- On-chip debugger: 1) TCB87-Type B + LC87D2708A or LC87F2708A
2) TCB87-Type B + LC87F2608A
3) TCB87-Type C (3 wire version) + LC87D2708A or LC87F2708A
4) TCB87-Type C (3 wire version) + LC87F2608A

■ Programming Board

Package	Programming Board
MFP10S	W87F27M-DBG
MFP10SK	
MFP14S	

■ Flash ROM Programming Board

Maker		Model	Version	Device
Flash Support Group, Inc. (FSG) + Our company (Note 4)	In-circuit Programmer	AF9101/AF9103 (Main body) (FSG models)	Rev.01.01 or later	LC87F2608A
		SIB87 (Inter Face Driver) (Our company model)		
Our company	Single/Gang Programmer	SKK-DBG Type B (Sanyo FWS)	Application Version 1.04 or later Chip Data Version 2.10 or later	LC87F2608A
	In-circuit/ Gang Programmer			

For information about AF-series:

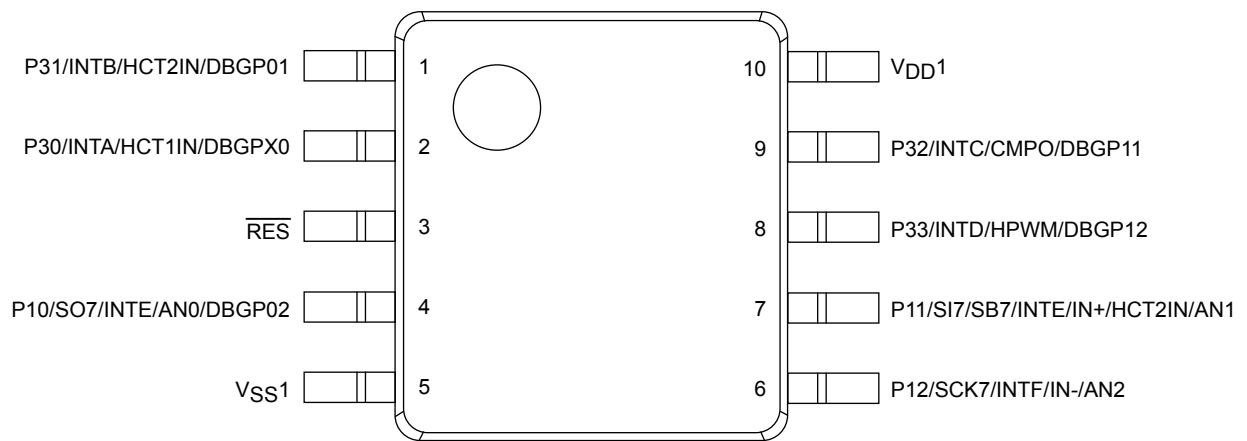
Flash Support Group, Inc.

TEL: +81-53-459-1050

E-mail: sales@j-fsg.co.jp

Note4: On-board-programmer from FSG (AF9101/AF9103) and serial interface driver from Our company (SIB87) together can give a PC-less, standalone on-board-programming capabilities.

Pin Assignment

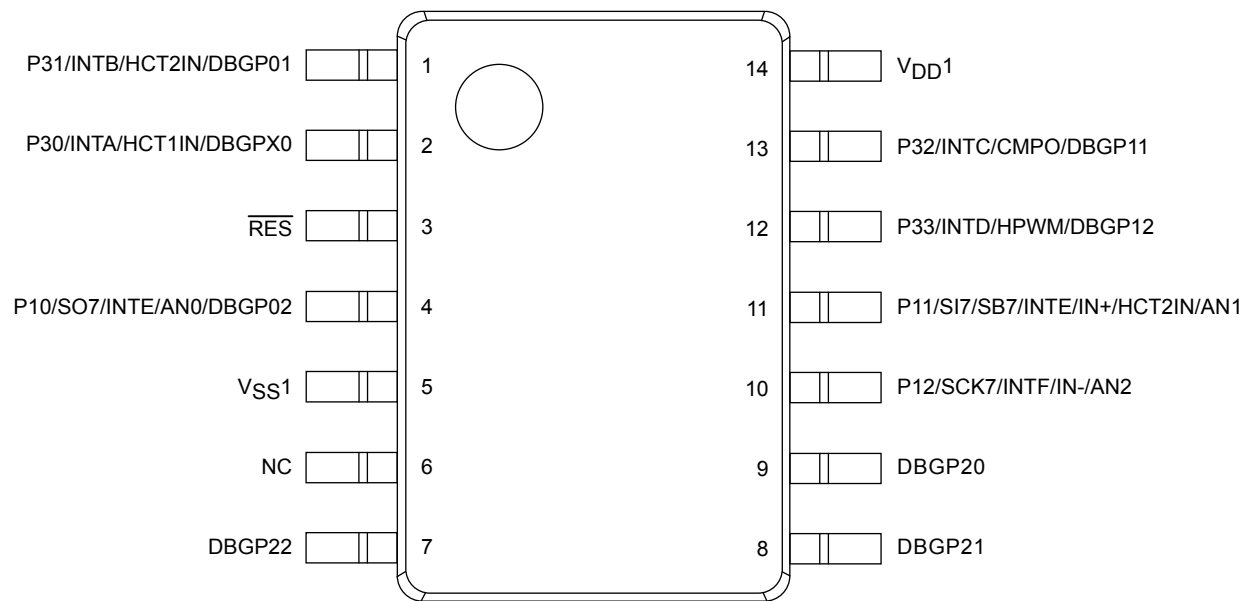


MFP10S “Lead-/Halogen-free type”

MFP10SK “Lead-/Halogen-free type”

MFP10S MFP10SK	NAME
1	P31/INTB/HCT2IN/DBGP01
2	P30/INTA/HCT1IN/DBGPX0
3	$\overline{\text{RES}}$
4	P10/SO7/INTE/AN0/DBGP02
5	V_{SS1}
6	P12/SCK7/INTF/IN-/AN2
7	P11/SI7/SB7/INTE/IN+/HCT2IN/AN1
8	P33/INTD/HPWM/DBGP12
9	P32/INTC/CMPO/DBGP11
10	V_{DD1}

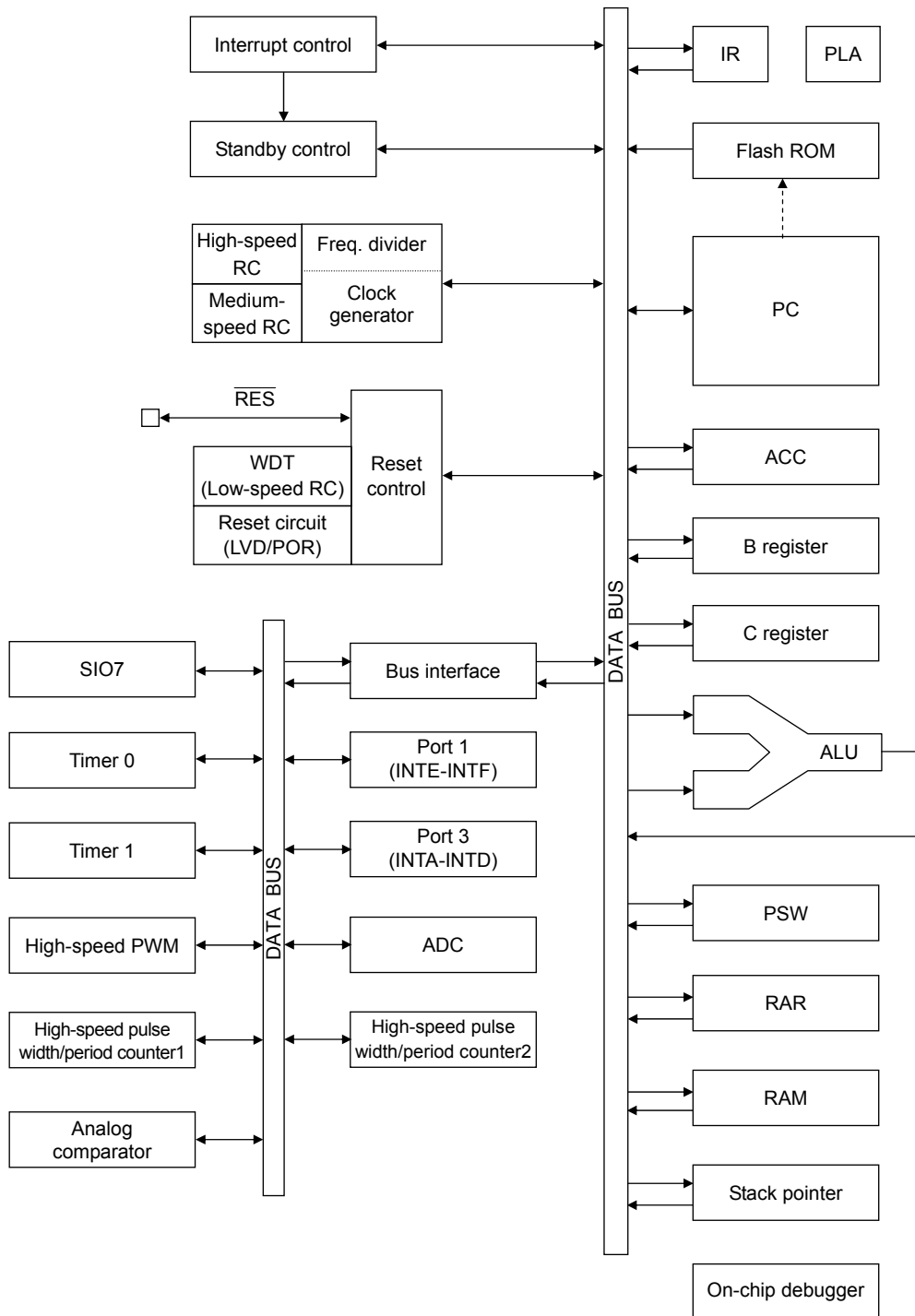
LC87F2608A



MFP14S (for debugging only) “Lead-free type”

MFP14S	NAME
1	P31/INTB/HCT2IN/DBGP01
2	P30/INTA/HCT1IN/DBGPX0
3	$\overline{\text{RES}}$
4	P10/SO7/INTE/AN0/DBGP02
5	V_{SS1}
6	NC
7	DBGP22
8	DBGP21
9	DBGP20
10	P12/SCK7/INTF/IN-/AN2
11	P11/SI7/SB7/INTE/IN+/HCT2IN/AN1
12	P33/INTD/HPWM/DBGP12
13	P32/INTC/CMPO/DBGP11
14	V_{DD1}

System Block Diagram



Pin Description

Pin Name	I/O	Description	Option																														
V _{SS} 1	-	- power supply pin	No																														
V _{DD} 1	-	+ power supply pin	No																														
PORT1 P10 to P12	I/O	• 3-bit I/O port • I/O specifiable in 1-bit units • Pull-up resistors can be turned on and off in 1-bit units • Multiplexed pins P10: SIO7 data output/ INTE input/HOLD release input/timer 1 event input/ timer 0L capture input/timer 0H capture input P11: SIO7 data input/bus I/O/ high-speed pulse width/period counter 2 input/t INTE input/HOLD release input/timer 1 event input/ timer 0L capture input/timer 0H capture input P12: SIO7 clock I/O/ INTF input/HOLD release input/timer 1 event input/ timer 0L capture input/timer 0H capture input AD converter input ports: AN0 to AN2 (P10 to P12) Analog comparator input ports: IN+, IN- (P11, P12) On-chip debugger pin 1: DBGP02 (P10) • Interrupt acknowledge type <table><tr><td></td><td>Rising</td><td>Falling</td><td>Rising & Falling</td><td>H level</td><td>L level</td></tr><tr><td>INTE</td><td>enable</td><td>enable</td><td>enable</td><td>disable</td><td>disable</td></tr><tr><td>INTF</td><td>enable</td><td>enable</td><td>enable</td><td>disable</td><td>disable</td></tr></table>		Rising	Falling	Rising & Falling	H level	L level	INTE	enable	enable	enable	disable	disable	INTF	enable	enable	enable	disable	disable	Yes												
	Rising	Falling	Rising & Falling	H level	L level																												
INTE	enable	enable	enable	disable	disable																												
INTF	enable	enable	enable	disable	disable																												
PORT3 P30 to P33	I/O	• 4-bit I/O port • I/O specifiable in 1-bit units • Pull-up resistors can be turned on and off in 1-bit units • Multiplexed pins P30: INTA input/HOLD release input/timer 0L capture input/ high-speed pulse width/period counter 1 input P31: INTB input/HOLD release input/timer 0H capture input/ high-speed pulse width/period counter 2 input P32: INTC input/HOLD release input/timer 0 event input/ timer 0L capture input/analog comparator output P33: INTD input/HOLD release input/timer 0 event input/ timer 0H capture input/high-speed PWM output On-chip debugger pin 1: DBGXP0 to DBGP01 (P30 to P31) On-chip debugger pin 2: DBGXP0 to DBGP12 (P30, P32 to P33) • Interrupt acknowledge type <table><tr><td></td><td>Rising</td><td>Falling</td><td>Rising & Falling</td><td>H level</td><td>L level</td></tr><tr><td>INTA</td><td>enable</td><td>enable</td><td>disable</td><td>enable</td><td>enable</td></tr><tr><td>INTB</td><td>enable</td><td>enable</td><td>disable</td><td>enable</td><td>enable</td></tr><tr><td>INTC</td><td>enable</td><td>enable</td><td>enable</td><td>disable</td><td>disable</td></tr><tr><td>INTD</td><td>enable</td><td>enable</td><td>enable</td><td>disable</td><td>disable</td></tr></table>		Rising	Falling	Rising & Falling	H level	L level	INTA	enable	enable	disable	enable	enable	INTB	enable	enable	disable	enable	enable	INTC	enable	enable	enable	disable	disable	INTD	enable	enable	enable	disable	disable	Yes
	Rising	Falling	Rising & Falling	H level	L level																												
INTA	enable	enable	disable	enable	enable																												
INTB	enable	enable	disable	enable	enable																												
INTC	enable	enable	enable	disable	disable																												
INTD	enable	enable	enable	disable	disable																												
RES	I/O	External reset input/internal reset output	No																														

Port Output Types

The table below lists the types of port outputs and the presence/absence of a pull-up resistor.
Data can be read into any input port even if it is in the output mode.

Port Name	Option Selected in Units of	Option Type	Output Type	Pull-up Resistor
P10 to P12	1 bit	1	CMOS	Programmable
		2	N-channel open drain	Programmable
P30 to P33	1 bit	1	CMOS	Programmable
		2	N-channel open drain	Programmable

On-chip Debugger Pin Processing

For the processing of the on-chip debugger pins, refer to the separately available documents entitled "RD87 On-chip Debugger Installation" and "LC872000 Series On-chip Debugger Pin Processing."

Recommended Unused Pin Connections

Pin Name	Recommended Unused Pin Connections	
	Board	Software
P10 to P12	OPEN	Set output low
P30 to P33	OPEN	Set output low

User Options

Option Name	Option Type	Flash Version	Option Switched in Unit of	Description
Port output type	P10 to P12	enable	1bit	CMOS
				N-channel open drain
	P30 to P33	enable	1bit	CMOS
				N-channel open drain
Program start address	-	enable	-	00000H
				01E00H
Brown-out detector reset function	Brown-out detector function	enable	-	Enable: Used
	Brown-out trip level	enable	-	Disable: Not used
Power-on-reset function	Power-on-reset level	enable	-	3 levels
High-speed RC oscillator circuit	Oscillation frequency	enable	-	20 MHz
				40 MHz
Package type	-	enable	-	MFP10S: LC87F2608A
				MFP14S: Debugged by using LC87D2708A or LC87F2708A

LC87F2608A

Absolute Maximum Ratings at Ta=25°C, VSS1=0V

Parameter	Symbol	Pin/Remarks	Conditions	VDD[V]	Specification			
					min	typ	max	unit
Maximum supply voltage	VDD max	VDD1			-0.3	to	+6.5	V
Input voltage	VI	RES			-0.3	to	VDD+0.3	
Input/output voltage	VIO	• Port 1 • Port 3			-0.3	to	VDD+0.3	
High level output current	Peak output current	IOPH(1)	Port 1	• CMOS output selected • Per applicable pin		-7.5		mA
		IOPH(2)	Port 3	• CMOS output selected • Per applicable pin		-10		
	Mean output current (Note 1-1)	IOMH(1)	Port 1	• CMOS output selected • Per applicable pin		-5		
		IOMH(2)	Port 3	• CMOS output selected • Per applicable pin		-7.5		
	Total output current	ΣIOAH(1)	• Port 10 • Ports 30, 31	Total of currents at all applicable pins		-20		
		ΣIOAH(2)	• Ports 11, 12 • Ports 32, 33	Total of currents at all applicable pins		-20		
		ΣIOAH(3)	• Port 1 • Port 3	Total of currents at all applicable pins		-35		
Low level output current	Peak output current	ILOPL(1)	Port 1	Per applicable pin			15	
		ILOPL(2)	Port 3	Per applicable pin			10	
	Mean output current (Note 1-1)	ILOML(1)	Port 1	Per applicable pin			10	
		ILOML(2)	Port 3	Per applicable pin			7.5	
	Total output current	ΣILOAL(1)	• Port 10 • Ports 30, 31	Total of currents at all applicable pins			25	
		ΣILOAL(2)	• Ports 11, 12 • Ports 32, 33	Total of currents at all applicable pins			35	
		ΣILOAL(3)	• Port 1 • Port 3	Total of currents at all applicable pins			55	
Power dissipation	Pd max(1)	MFP10S	• Ta=-40 to +85°C • Independent package				100	mW
	Pd max(2)		• Ta=-40 to +85°C • Mounted on thermal test board (Note 1-2)				237	
	Pd max(3)	MFP10SK	• Ta=-40 to +85°C • Independent package				100	
	Pd max(4)		• Ta=-40 to +85°C • Mounted on thermal test board (Note 1-2)				237	
Operating ambient temperature	Topr				-40	to	+85	°C
Storage ambient temperature	Tstg				-55	to	+125	

Note 1-1: Mean output current refers to the average of output currents measured for a period of 100ms.

Note 1-2: Thermal test board used conforms to SEMI (size: 76.1×114.3×1.6mm, glass epoxy board).

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

LC87F2608A

Allowable Operating Conditions at Ta= -40 to +85°C, VSS1=0V

Parameter	Symbol	Pin/Remarks	Conditions	Specification				
				V _{DD} [V]	min	typ	max	unit
Operating supply voltage (Note 2-1)	V _{DD}	V _{DD} 1	0.272μs ≤ tCYC ≤ 100μs		2.7		5.5	V
Memory sustaining supply voltage	V _{HD}	V _{DD} 1	RAM and register contents sustained in HOLD mode		2.0		5.5	
High level input voltage	V _{IH} (1)	• Port 1 • Port 3	Output disabled	2.7 to 5.5	0.3V _{DD} +0.7		V _{DD}	
	V _{IH} (2)	$\overline{\text{RES}}$		2.7 to 5.5	0.75V _{DD}		V _{DD}	
Low level input voltage	V _{IL} (1)	• Port 1 • Port 3	Output disabled	4.0 to 5.5	V _{SS}		0.1V _{DD} +0.4	
				2.7 to 4.0	V _{SS}		0.2V _{DD}	
	V _{IL} (2)	$\overline{\text{RES}}$		2.7 to 5.5	V _{SS}		0.25V _{DD}	
Instruction cycle time (Note 2-2)	tCYC			2.7 to 5.5	0.272		100	μs
Oscillation frequency range	FmHRC(1)		• High-speed RC oscillation • 40MHz selected as option • Ta=-20 to +85°C	4.5 to 5.5	38	40	42	MHz
	FmHRC(2)		• High-speed RC oscillation • 40MHz selected as option • Ta=-40 to +85°C	4.5 to 5.5	37.6	40	42.4	
	FmHRC(3)			3.5 to 5.5	36.8	40	43.2	
	FmHRC(4)			2.7 to 5.5	32	40	43.2	
	FmHRC(5)		• High-speed RC oscillation • 20MHz selected as option • Ta=-20 to +85°C	3.0 to 5.5	19	20	21	
	FmHRC(6)		• High-speed RC oscillation • 20MHz selected as option • Ta=-40 to +85°C	2.7 to 5.5	18.7	20	21.3	
	FmRC		Medium-speed RC oscillation	2.7 to 5.5	0.5	1.0	2.0	
	FmSLRC		Low-speed RC oscillation	2.7 to 5.5	15	30	60	kHz
Oscillation stabilization time	tmsHRC		• When high-speed RC oscillation state is switched from stopped to enabled. • See Fig. 2.	2.7 to 5.5			100	μs

Note 2-1: Use this product in a voltage range of 3.0 to 5.5V because the minimum release voltage (PORRL) of the power-on reset (POR) circuit is 2.87V±0.12V.

Note 2-2: Relationship between tCYC and oscillation frequency is as follows:

- When system clock source is set to medium-speed RC oscillation
3/FmRC at a division ratio of 1/1, 6/FmRC at a division ratio of 1/2, 12/FmRC at a division ratio of 1/4, and so forth
- When system clock source is set to high-speed RC oscillation (40MHz selected by optional configuration)
12/FmHRC at a division ratio of 1/1, 24/FmHRC at a division ratio of 1/2, 48/FmHRC at a division ratio of 1/4, and so forth
- When system clock source is set to high-speed RC oscillation (20MHz selected by optional configuration)
6/FmHRC at a division ratio of 1/1, 12/FmHRC at a division ratio of 1/2, 24/FmHRC at a division ratio of 1/4, and so forth

LC87F2608A

Electrical Characteristics at Ta= -40 to +85°C, V_{SS}=0V

Parameter	Symbol	Pin/Remarks	Conditions	Specification				
				V _{DD} [V]	min	typ	max	unit
High level input current	I _{IH} (1)	• Port 1 • Port 3	• Output disabled • Pull-up resistor off • V _{IN} =V _{DD} (including output Tr. off leakage current)	2.7 to 5.5			1	μA
	I _{IH} (2)	$\overline{\text{RES}}$	V _{IN} =V _{DD}	2.7 to 5.5			1	
Low level input current	I _{IL}	• Port 1 • Port 3	• Output disabled • Pull-up resistor off • V _{IN} =V _{SS} (including output Tr. off leakage current)	2.7 to 5.5	-1			
High level output voltage	V _{OH} (1)	CMOS output type port 1	I _{OH} =-1mA	4.5 to 5.5	V _{DD} -1			V
	V _{OH} (2)		I _{OH} =-0.35mA	2.7 to 5.5	V _{DD} -0.4			
	V _{OH} (3)	CMOS output type port 3	I _{OH} =-5mA	4.5 to 5.5	V _{DD} -1.5			
	V _{OH} (4)		I _{OH} =-0.7mA	2.7 to 5.5	V _{DD} -0.4			
Low level output voltage	V _{OL} (1)	Port 1	I _{OL} =10mA	4.5 to 5.5			1.5	
	V _{OL} (2)		I _{OL} =1.4mA	2.7 to 5.5			0.4	
	V _{OL} (3)	Port 3	I _{OL} =5mA	4.5 to 5.5			1.5	
	V _{OL} (4)		I _{OL} =0.7mA	2.7 to 5.5			0.4	
Pull-up resistance	R _{pu} (1)	• Port 1	V _{OH} =0.9V _{DD}	4.5 to 5.5	15	35	80	kΩ
	R _{pu} (2)	• Port 3		2.7 to 4.5	18	50	150	
	R _{pu} (3)	$\overline{\text{RES}}$		2.7 to 5.5	216	360	504	
Hysteresis voltage	V _{HYS}	• Port 1 • Port 3 • $\overline{\text{RES}}$		2.7 to 5.5		0.1V _{DD}		V
Pin capacitance	CP	All pins	• V _{IN} =V _{SS} for pins other than that under test • f=1 MHz • Ta=25°C	2.7 to 5.5		10		pF

LC87F2608A

Serial I/O Characteristics at Ta= -40 to +85°C, V_{SS}1=0V

SI07 Serial I/O Characteristics (Note 4-1-1)

Parameter			Symbol	Pin/Remarks	Conditions	V _{DD} [V]	Specification			
							min	typ	max	unit
Serial clock	Input clock	Frequency	tSCK(1)	SCK7(P12)	- See Fig. 4. (Note 4-1-2)	2.7 to 5.5	2			tCYC
		Low level pulse width	tSCKL(1)				1			
		High level pulse width	tSCKH(1)				1			
	Output clock	Frequency	tSCK(2)	SCK7(P12)	- CMOS output selected - See Fig. 4.	2.7 to 5.5	4/3			tSCK
		Low level pulse width	tSCKL(2)				1/2			
		High level pulse width	tSCKH(2)				1/2			
Serial input	Data setup time		tsDI(1)	SB7(P11), SI7(P11)	- Must be specified with respect to Rising edge of SIOCLK. - See Fig. 4.	2.7 to 5.5	0.03			μs
	Data hold time		thDI(1)				0.03			
Serial output	Input clock	Output delay time	tdDO(1)	SO7(P10), SB7(P11)	- Must be specified with respect to rising edge of SIOCLK. - Must be specified as the time to the beginning of output state change in open drain output mode. - See Fig. 4.	2.7 to 5.5				1tCYC +0.05
	Output clock		tdDO(2)							(1/3)tCYC +0.05

Note 4-1-1: These specifications are theoretical values. Add margin depending on its use.

Note 4-1-2: To use serial-clock-input in transmission/reception mode, the time from SI7RUN being set when serial clock is "H" to the first falling edge of the serial clock must be longer than 1tCYC.

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AD Converter Characteristics at $V_{SS1}=0V$

<12-bit AD conversion mode at $T_a=-40$ to $+85^{\circ}C$ >

Parameter	Symbol	Pin/Remarks	Conditions	V _{DD} [V]	Specification			
					min	typ	max	unit
Resolution	N	AN0(P10) to AN2(P12)		3.0 to 5.5		12		bit
Absolute accuracy	ET		(Note 7-1)	3.0 to 5.5			±16	LSB
Conversion time	tCAD		• See "Conversion time calculation method." (Note 7-2)	4.0 to 5.5	38		104.3	μs
				3.0 to 5.5	75.8		104.3	
Analog input voltage range	VAIN			3.0 to 5.5	V _{SS}		V _{DD}	V
Analog port input current	IAINH		VAIN= V _{DD}	3.0 to 5.5			1	μA
	IAINL		VAIN= V _{SS}	3.0 to 5.5	-1			

<8-bit AD Converter Mode at $T_a=-40$ to $+85^{\circ}C$ >

Parameter	Symbol	Pin/Remarks	Conditions	Specification				
				V _{DD} [V]	min	typ	max	unit
Resolution	N	AN0(P10) to AN2(P12)		3.0 to 5.5		8		bit
Absolute accuracy	ET		(Note 7-1)	3.0 to 5.5			±1.5	LSB
Conversion time	tCAD		• See "Conversion time calculation method." (Note 7-2)	4.0 to 5.5	23.4		64.3	μs
				3.0 to 5.5	46.7		64.3	
Analog input voltage range	VAIN			3.0 to 5.5	V _{SS}		V _{DD}	V
Analog port input current	IAINH		VAIN= V _{DD}	3.0 to 5.5			1	μA
	IAINL		VAIN= V _{SS}	3.0 to 5.5	-1			

<Conversion time calculation method>

12-bit AD conversion mode: $tCAD$ (conversion time) = $((52/(\text{division ratio})) + 2) \times (1/3) \times tCYC$

8-bit AD conversion mode: $tCAD$ (conversion time) = $((32/(\text{division ratio})) + 2) \times (1/3) \times tCYC$

<Recommended Operating Conditions>

High-speed RC Oscillation (FmHRC)	Supply Voltage Range (V_{DD})	System Clock Division Ratio (SYSDIV)	Cycle Time (tCYC)	AD Division Ratio (ADDIV)	Conversion Time (tCAD)	
					12-bit AD	8-bit AD
40MHz/20MHz	4.0V to 5.5V	1/1	300ns	1/8	41.8 μs	25.8 μs
	3.0V to 5.5V	1/1	300ns	1/16	83.4 μs	51.4 μs

Note 7-1: The quantization error ($\pm 1/2LSB$) is excluded from the absolute accuracy. The absolute accuracy is measured when no change occurs in the I/O state of the pins that are adjacent to the analog input channel during AD conversion processing.

Note 7-2: The conversion time refers to the interval from the time a conversion starting instruction is issued till the time the complete digital conversion value against the analog input value is loaded in the result register.

*The conversion time is twice the normal value when one of the following conditions occurs:

- The first AD conversion executed in the 12-bit AD conversion mode after a system reset.
- The first AD conversion executed after the AD conversion mode is switched from 8-bit to 12-bit AD conversion mode.

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Power-on Reset (POR) Characteristics at Ta= -40 to +85°C, V_{SS} 1=0V

Parameter	Symbol	Pin/Remarks	Conditions	Option Selecting Voltage	Specification			
					min	typ	max	unit
POR release voltage	PORRL		- Option selected - See Fig. 6. (Note 8-1)	2.87V	2.75	2.87	2.99	V
				3.86V	3.73	3.86	3.99	
				4.35V	4.21	4.35	4.49	
Unknown voltage area	POUKS		See Fig. 6. (Note 8-2)			0.7	0.95	
Power startup time	PORIS		Power startup time from V _{DD} =0V to 2.8V				100	ms

Note 8-1: The POR release voltage can be selected from three levels when the low-voltage detection feature is deselected.

Note 8-2: There is an unpredictable period before the power-on reset transistor starts to turn on.

Low-voltage Detection (LVD) Characteristics at Ta=-40 to +85°C, V_{SS} 1=0V

Parameter	Symbol	Pin/Remarks	Conditions	Option Selecting Voltage	Specification			
					min	typ	max	unit
LVD reset voltage (Note 9-2)	LVDET		- Option selected - See Fig. 7. (Note 9-1) (Note 9-3)	2.81V	2.71	2.81	2.91	V
				3.79V	3.69	3.79	3.89	
				4.28V	4.18	4.28	4.38	
LVD voltage hysteresis	LVHYS			2.81V		60		mV
				3.79V		65		
				4.28V		65		
Unknown voltage area	LVUKS		See Fig. 7. (Note 9-4)			0.7	0.95	V
Minimum low voltage detection width (response sensitivity)	tLVDW		- LVDET-0.5V - See Fig. 8.		0.2			ms

Note 9-1: The LVD reset voltage can be selected from three levels when the low-voltage detection feature is selected.

Note 9-2: The hysteresis voltage is not included in the LVD reset voltage value.

Note 9-3: There are cases when the LVD reset voltage value is exceeded when a greater change in the output level or large current is applied to the port.

Note 9-4: There is an unpredictable period before the low-voltage detection resetting transistor starts to run.

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Consumption Current Characteristics at Ta=-40 to +85°C, VSS 1=0V

Parameter	Symbol	Pin/Remarks	Conditions	Specification				
				VDD [V]	min	typ	max	unit
Normal mode consumption current (Note 10-1)	IDDOP(1)	VDD1	- FmHRC=40MHz oscillation mode - System clock set to high-speed RC, 10MHz (1/4 of 40MHz) - Medium-speed RC oscillation stopped - System clock frequency division ratio set to 1/1	4.5 to 5.5		7.8	14	mA
	IDDOP(2)			2.7 to 3.6		4.9	9.4	
	IDDOP(3)		- FmHRC=20MHz oscillation mode - System clock set to high-speed RC, 10MHz (1/2 of 20MHz) - Medium-speed RC oscillation stopped - System clock frequency division ratio set to 1/1	4.5 to 5.5		7.1	12.8	
	IDDOP(4)			2.7 to 3.6		4.5	8.6	
	IDDOP(5)		- High-speed RC oscillation stopped - System clock set to medium-speed RC oscillation mode - System clock frequency division ratio set to 1/2	4.5 to 5.5		0.60	1.9	
	IDDOP(6)			2.7 to 3.6		0.38	1.3	
HALT mode consumption current (Note 10-1)	IDDHALT(1)		HALT mode - FmHRC=40MHz oscillation mode - System clock set to high-speed RC, 10MHz(1/4 of 40MHz) - Medium-speed RC oscillation stopped - System clock frequency division ratio set to 1/1	4.5 to 5.5		3.2	5.0	
	IDDHALT(2)			2.7 to 3.6		2.0	3.1	
	IDDHALT(3)		HALT mode - FmHRC=20MHz oscillation mode - System clock set to high-speed RC, 10MHz (1/2 of 20MHz) - Medium-speed RC oscillation stopped - System clock frequency division ratio set to 1/1	4.5 to 5.5		2.5	3.9	
	IDDHALT(4)			2.7 to 3.6		1.6	2.5	
	IDDHALT(5)		HALT mode - High-speed RC oscillation stopped - System clock set to medium-speed RC oscillation mode - System clock frequency division ratio set to 1/2	4.5 to 5.5		0.32	1.0	
	IDDHALT(6)			2.7 to 3.6		0.16	0.55	
HOLD mode consumption current (Note 10-1)	IDDHOLD(1)		HOLD mode Ta=-10 to +50°C	4.5 to 5.5		0.04	3.0	μA
	IDDHOLD(2)			2.7 to 3.6		0.02	1.8	
	IDDHOLD(3)		HOLD mode Ta=-40 to +85°C	4.5 to 5.5		0.04	34	
	IDDHOLD(4)			2.7 to 3.6		0.02	22	
	IDDHOLD(5)		HOLD mode - LVD option selected - Ta=-10 to +50°C	4.5 to 5.5		3.1	6.8	
	IDDHOLD(6)			2.7 to 3.6		2.4	4.2	
	IDDHOLD(7)		HOLD mode - LVD option selected - Ta=-40 to +85°C	4.5 to 5.5		3.1	39	
	IDDHOLD(8)			2.7 to 3.6		2.4	25	
	IDDHOLD(9)		HOLD mode - Watchdog timer active - Ta=-10 to +50°C	4.5 to 5.5		3.4	10	
	IDDHOLD(10)			2.7 to 3.6		1.7	6.0	
	IDDHOLD(11)		HOLD mode - Watchdog timer active - Ta=-40 to +85°C	4.5 to 5.5		3.4	42	
	IDDHOLD(12)			2.7 to 3.6		1.7	27	
	IDDHOLD(13)		HOLD mode Comparator active	4.5 to 5.5		110	160	
	IDDHOLD(14)		(IN+= VDD, IN-= VSS)	2.7 to 3.6		65	100	

Note 10-1: The consumption current value includes none of the currents that flow into the output Tr and internal pull-up resistors.

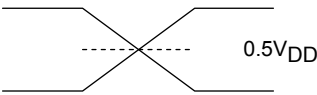
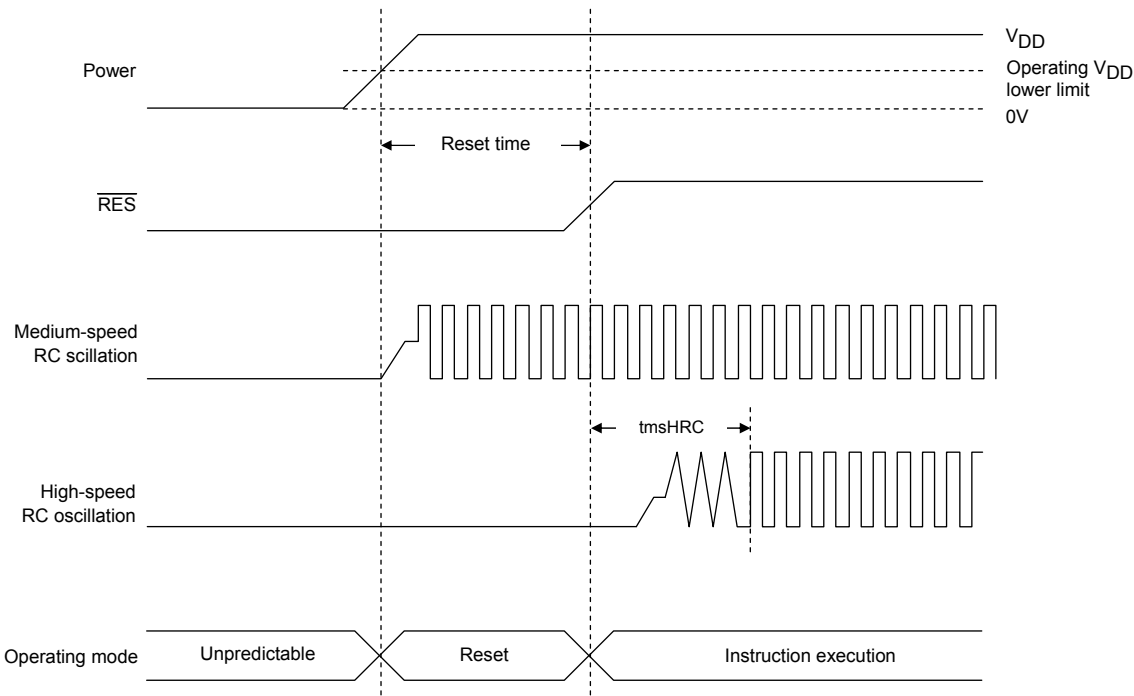
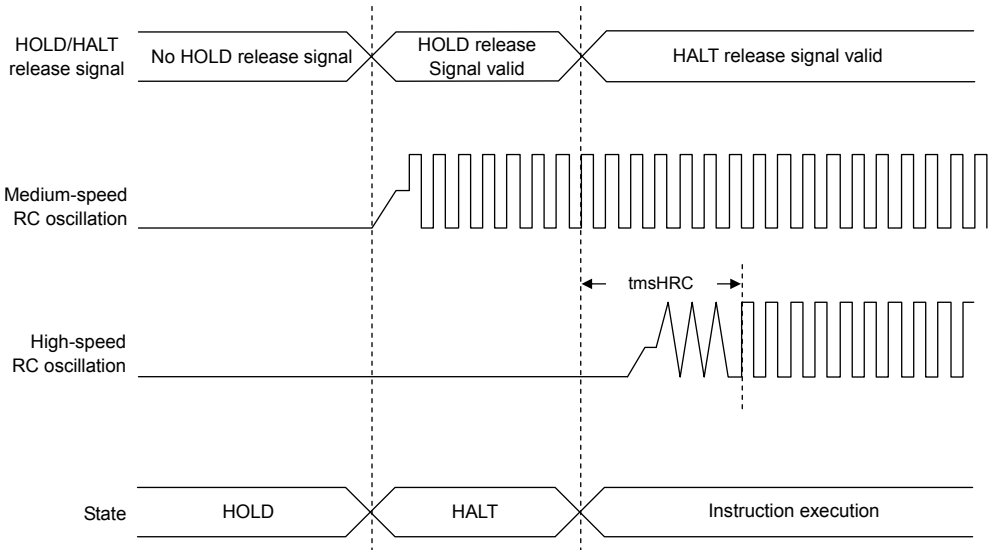


Figure 1 AC Timing Measurement Point

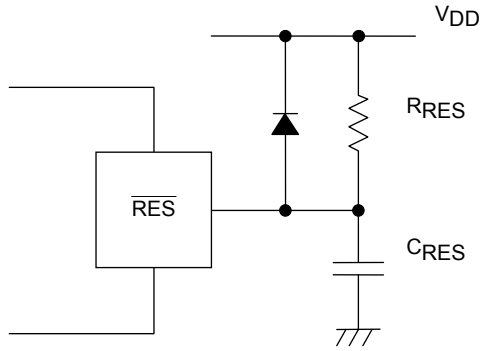


Reset Time and Oscillation Stabilization Time



HOLD Release Signal and Oscillation Stabilization Time

Figure 2 Oscillation Stabilization Times



Note:

The external peripheral circuit differs depending on the way in which the power-on reset and low-voltage detection reset functions are used. Refer to the Chapter, entitled "Reset Function," of the user's manual.

Figure 3 Sample Reset Circuit

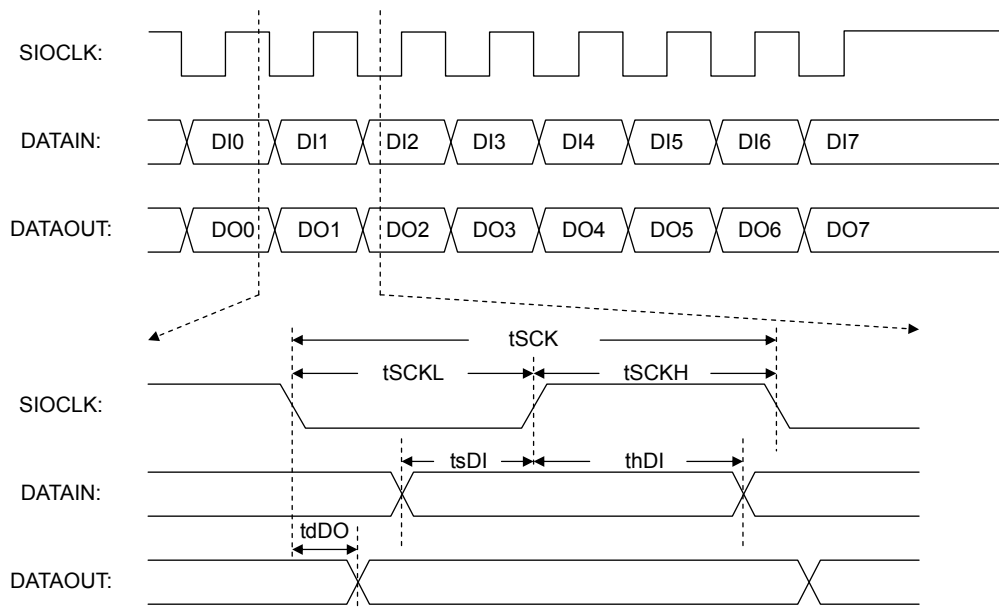


Figure 4 Serial I/O Waveforms

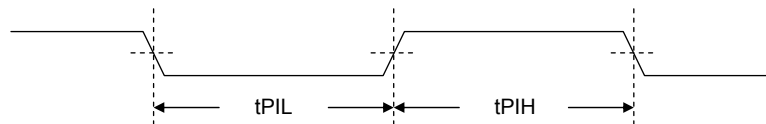


Figure 5 Pulse Input Timing Signal Waveform

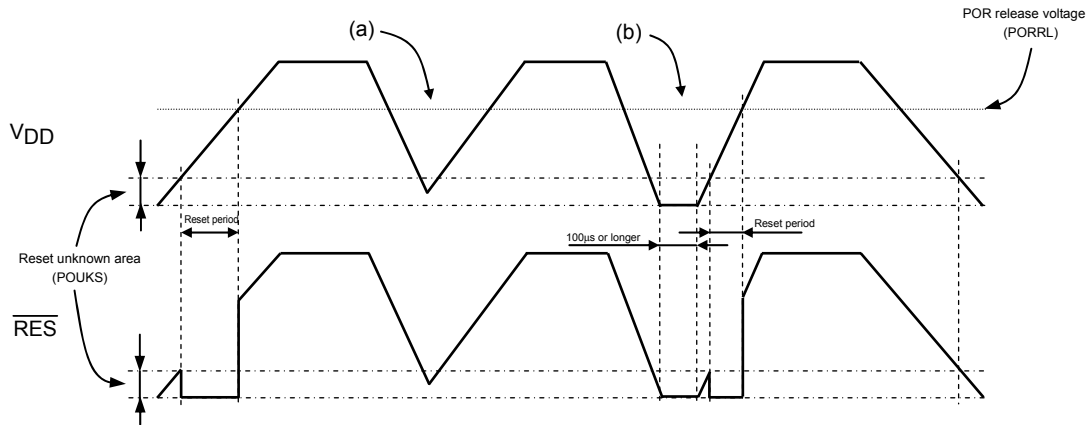


Figure 6 Example of POR Only (LVD Deselected) Mode Waveforms (at Reset Pin with RRES Pull-up Resistor Only)

- The POR circuit generates a reset signal only when the power voltage is raised from the V_{SS} level.
- No stable reset signal is generated if power is turned on again when the power voltage does not go down to the V_{SS} level as shown in (a). If this case is anticipated, use the LVD function as explained below or configure an external reset circuit.
- A reset is effected only when power is turned on again after the power voltage goes down to and remains at the V_{SS} level for 100µs or longer as shown in (b).

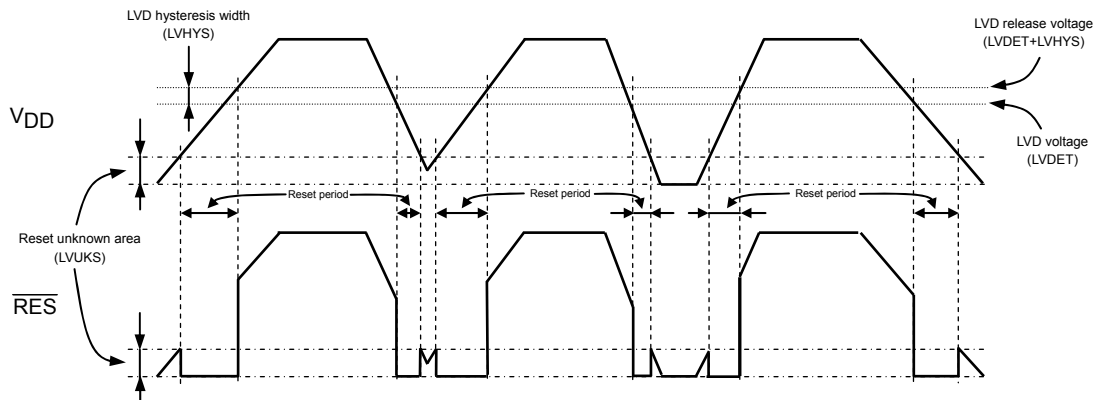


Figure 7 Example of POR + LVD Mode Waveforms (at Reset Pin with RRES Pull-up Resistor Only)

- A reset is effected both when power is turned on and when it goes down.
- The hysteresis width (LVHYS) is introduced in the LVD circuit to prevent the iterations of the IC entering and exiting the reset state near the detection threshold level.

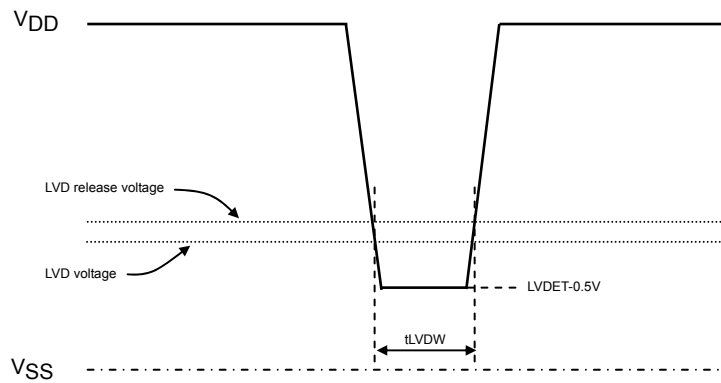


Figure 8 Minimum Low Voltage Detection Width
(Example of Short Interruption of Power/ Power Fluctuation Waveform)

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